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		First Named Inventor	Forbes, Leonard	
	1 2000 B	Group Art Unit	2815	
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	Filing Date	July 29, 1997
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1 1 1 1	Examiner Name	Wilson, Allan
Sheet 1 of 1	Attorney Docket No: 3	303.356US1

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Atty. Docket No.: 303.356US1

Serial No. 08/902,133

Applicant: Leonard Forbes et al.

Filing Date: July 29, 1997

Group: 2503-2815

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Atty. Docket No.: 303.356US1 Applicant: Leonard Forbes et al. Serial No. 08/902,133

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